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Industrial communication networks – Profiles – Part 5-2: Installation of fieldbuses – Installation profiles for CPF 2



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INDUSTRIAL COMMUNICATION NETWORKS – PROFILES –

Part 5-2: Installation of fieldbuses – Installation profiles for CPF 2

FOREWORD

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This consolidated version of the official IEC Standard and its amendment has been prepared for user convenience.

IEC 61784-5-2 edition 4.1 contains the fourth edition (2018-08) [documents 65C/924/FDIS and 65C/925/RVD] and its amendment 1 (2024-03) [documents 65C/1283/FDIS and 65C/1297/RVD].

In this Redline version, a vertical line in the margin shows where the technical content is modified by amendment 1. Additions are in green text, deletions are in strikethrough red text. A separate Final version with all changes accepted is available in this publication.

International Standard IEC 61784-5-2 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation.

This document is to be used in conjunction with IEC 61918:2018, IEC 61918:2018/AMD1:2022 and IEC 61918:2018/AMD2:2024.

This fourth edition cancels and replaces the third edition published in 2013. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

a) references to ISO/IEC 24702 have been replaced with references to ISO/IEC 11801-3 in Table B.1;

b) errors have been corrected;

c) Tables B11 and B13 have been added in support of 1,000 Mb/s 4 Pair Ethernet;

d) Clarification of dual power supplies for Annex C.

~~This standard is to be used in conjunction with IEC 61918:2018.~~

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts of IEC 61784-5 series, under the general title *Industrial communication networks – Profiles – Installation of fieldbuses,* can be found on the IEC website.

The committee has decided that the contents of this document and its amendment will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn, or
- revised.

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INTRODUCTION

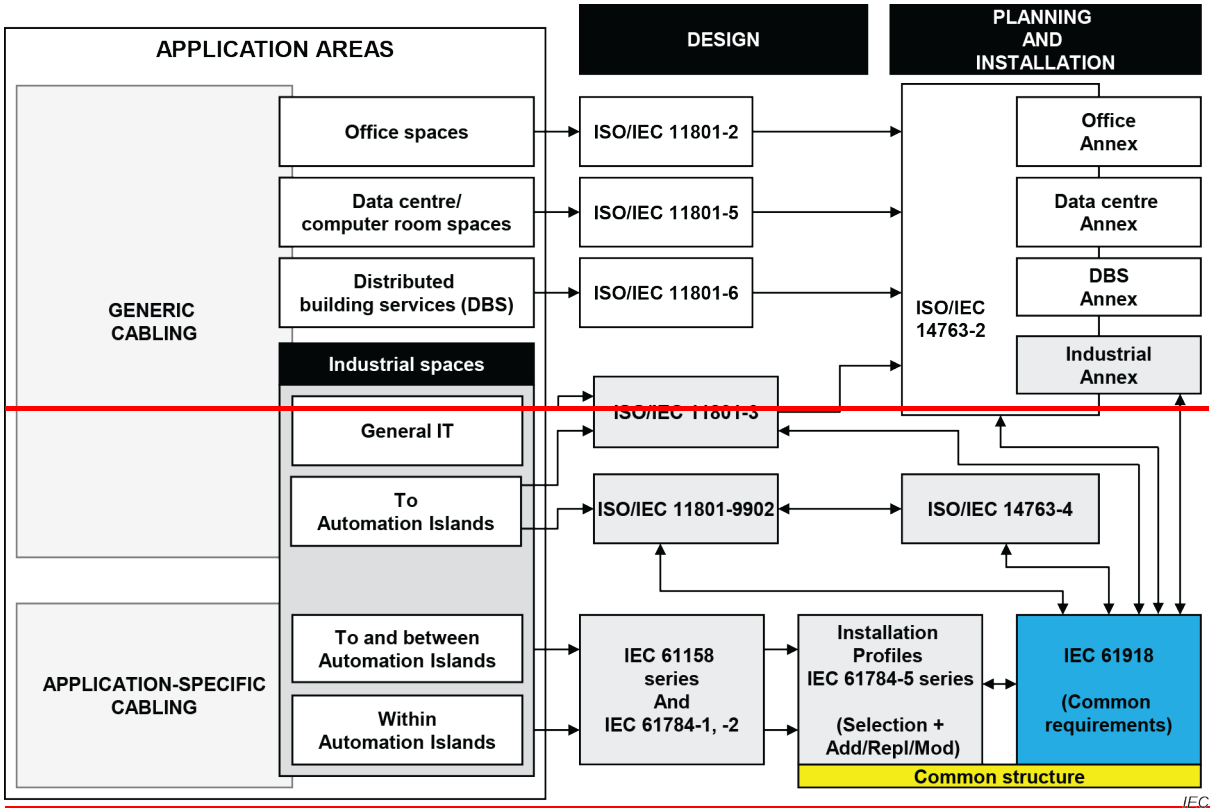
This ~~International Standard~~ document is one of a series produced to facilitate the use of communication networks in industrial control systems.

IEC 61918:2018, IEC 61918:2018/AMD1:2022 and IEC 61918:2018/AMD2:2024 provide~~s~~ the common requirements for the installation of communication networks in industrial control systems. This installation profile standard provides the installation profiles of the communication profiles (CP) of a specific communication profile family (CPF) by stating which requirements of IEC 61918 fully apply and, where necessary, by supplementing, modifying, or replacing the other requirements (see Figure 1).

For general background on fieldbuses, their profiles, and relationship between the installation profiles specified in this document, see IEC 61158-1.

Each CP installation profile is specified in a separate annex of this document. Each annex is structured exactly as the reference standard IEC 61918 for the benefit of the persons representing the roles in the fieldbus installation process as defined in IEC 61918 (planner, installer, verification personnel, validation personnel, maintenance personnel, administration personnel). By reading the installation profile in conjunction with IEC 61918, these persons immediately know which requirements are common for the installation of all CPs and which are modified or replaced. The conventions used to draft this document are defined in Clause 5.

The provision of the installation profiles in one standard for each CPF (for example IEC 61784-5-2 for CPF 2) allows readers to work with standards of a convenient size.



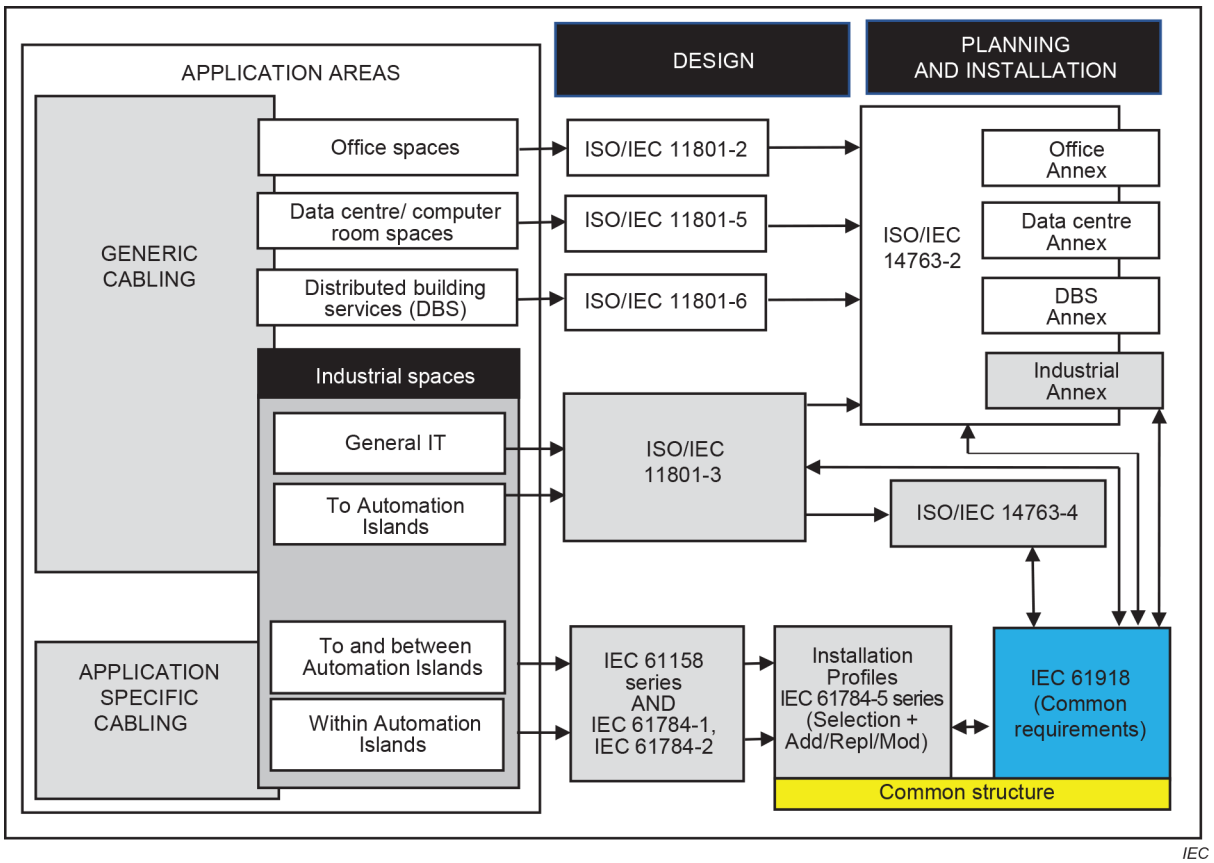


Figure 1 – Standards relationships

INTRODUCTION to Amendment 1

This Amendment 1 includes the following significant technical changes with respect to IEC 61784-5-2:2018:

a) Updated references of IEC 61918:2018 to include additions of IEC 61918:2018/AMD1:2022 and IEC 61918:2018/AMD2:2024,

b) Added references for consideration of security to Subclause B.4.2.2,

c) Updated optical fiber specifications and references in Subclauses B.4.3.3.2 and B.4.4.1.4,

d) Added definition of electromagnetic compatibility options for conformance to Subclause B.4.4.1.2.1,

e) Added support of mesh bonding systems to Subclause B.4.4 and Clause B.5,

f) Added acceptance of end-to-end link verification and certification testing to Clause B.6.

INDUSTRIAL COMMUNICATION NETWORKS – PROFILES –

Part 5-2: Installation of fieldbuses – Installation profiles for CPF 2

1 Scope

This part of IEC 61784-5 specifies the installation profiles for CPF 2 (CIP™[1]).

The installation profiles are specified in the annexes. These annexes are read in conjunction with IEC 61918:2018, IEC 61918:2018/AMD1:2022 and IEC 61918:2018/AMD2:2024.

2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61918:2018[2], *Industrial communication networks – Installation of communication networks in industrial premises*
IEC 61918:2018/AMD1:2022
IEC 61918:2018/AMD2:2024

~~The normative references of IEC 61918:2018, Clause 2, apply.~~

NOTE For profile specific normative references, see Clauses A.2, B.2, and C.2.

3 Terms, definitions and abbreviated terms

For the purpose of this document, the terms, definitions and abbreviated terms given in IEC 61918:2018 Clause 3, IEC 61918:2018/AMD1:2022, Clause 3, and Clauses A.3, B.3, C.3 of this document, apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
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~~NOTE For profile specific terms, definitions and abbreviated terms, see Clauses A.3, B.3, and C.3.~~

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1 CIP™ (Common Industrial Protocol) is a trade name of ODVA, Inc. This information is given for the convenience of users of this International Standard and does not constitute an endorsement by IEC of the trademark holder or any of its products. Compliance to this document does not require use of the trade name CIP™. Use of the trade name CIP™ requires permission of ODVA, Inc.

2 The normative references of IEC 61918:2018, Clause 2, IEC 61918:2018/AMD1:2022, Clause 2 and IEC 61918:2018/AMD2:2024, Clause 2, apply.